Replacement Sheet Serial No.: 10/724,530 Inventor: Raymond Kuang

Docket No.: ACT-379 Page 1 of 3

Submitted on July 6, 2005 with Issue Fee Filed: November 26, 2003

Title: Chip Carrier Substrate with a Land Grid Array and External Bond Terminals

Attorney: Kenneth D'Alessandro

Sierra Patent Group, Ltd.



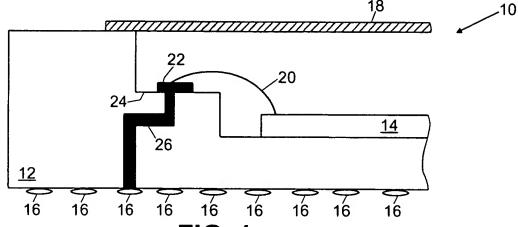


FIG. 1 PRIOR ART

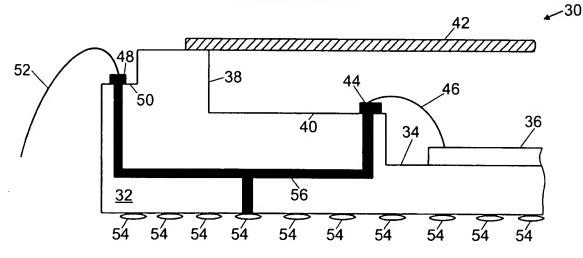


FIG. 2A /30 42 48 52 -38 46 40 36 56 <u>32</u> 54 54 54

FIG. 2B

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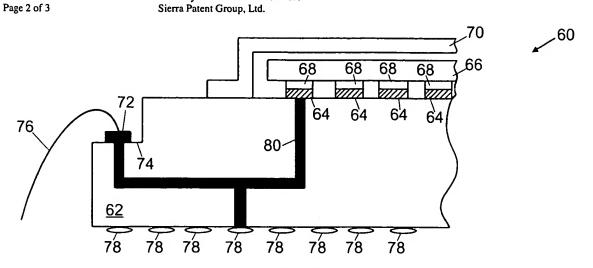


FIG. 3A

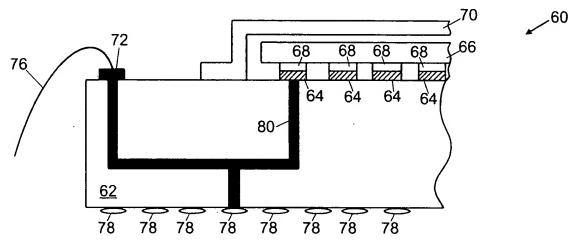


FIG. 3B

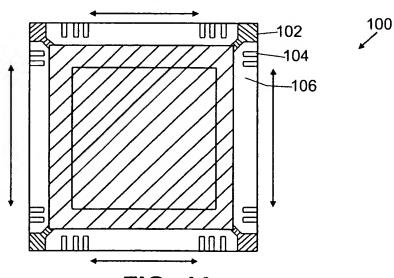


FIG. 4A

Replacement Sheet Serial No.: 10/724,530 Inventor: Raymond Kuang

Docket No.: ACT-379

Page 3 of 3

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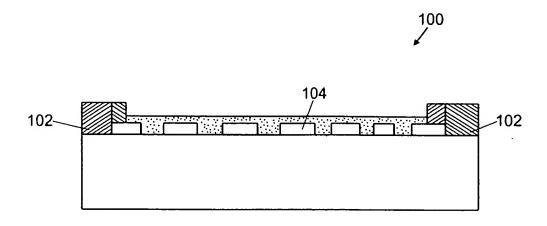


FIG. 4B

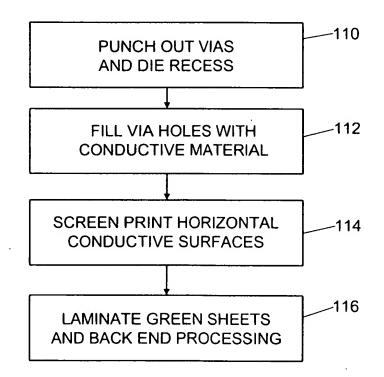


FIG. 5